

Revision 20200226

LEXAN[™] RESIN EX6681T

REGION EUROPE

DESCRIPTION

LEXAN^M EX6681T is a coextrusion product which is UV stabilized for good outdoor weathering of LEXAN^M sheet and excellent processing.

TYPICAL PROPERTY VALUES

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL			
Tensile Stress, yield, 50 mm/min	63	MPa	ISO 527
Tensile Stress, break, 50 mm/min	70	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	6	%	ISO 527
Tensile Strain, break, 50 mm/min	120	%	ISO 527
Tensile Modulus, 1 mm/min	2350	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	90	MPa	ISO 178
Flexural Modulus, 2 mm/min	2300	MPa	ISO 178
THERMAL			
Vicat Softening Temp, Rate B/120	135	°C	ISO 306
PHYSICAL			
Density	1.2	g/cm³	ISO 1183
Melt Volume Rate, MVR at 300°C/1.2 kg	10	cm³/10 min	ISO 1133
PROFILE EXTRUSION			
Drying Temperature	105	°C	
Drying Time	2 – 3	hrs	
Melt Temperature	220 – 250	°C	
Barrel - Zone 1 Temperature	240 - 280	°C	
Barrel - Zone 2 Temperature	240 - 280	°C	
Barrel - Zone 3 Temperature	220 – 240	°C	
Barrel - Zone 4 Temperature	220 - 240	°C	
Hopper Temperature	60 - 80	°C	
Adapter Temperature	220 – 240	°C	
Die Temperature	245 – 290	°C	
Calibrator Temperature	60 – 100	°C	

DISCLAIMER

Any sale by SABIC, its subsidiaries and affiliates (each a "seller"), is made exclusively under seller's standard conditions of sale (available upon request) unless agreed otherwise in writing and signed on behalf of the seller. While the information contained herein is given in good faith, SELLER MAKES NO WARRANTY, EXPRESS OR IMPLIED, INCLUDING MERCHANTABILITY AND NONINFRINGEMENT OF INTELLECTUAL PROPERTY, NOR ASSUMES ANY LIABILITY, DIRECT OR INDIRECT, WITH RESPECT TO THE PERFORMANCE, SUITABILITY OR FITNESS FOR INTENDED USE OR PURPOSE OF THESE PRODUCTS IN ANY APPLICATION. Each customer must determine the suitability of seller materials for the customer's particular use through appropriate testing and analysis. No statement by seller concerning a possible use of any product, service or design is intended, or should be construed, to grant any license under any patent or other intellectual property right.